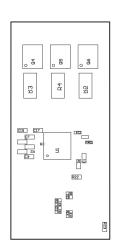
This Assembly Note uill show in the PcbBoc and associated outputs

Z21
This Assembly Note uill shou's the PcbBoc and associated outputs
This Assembly Note uill shou's the PcbBoc and associated outputs

## COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: TIDA-00643	REV: E2	SVN REV	: Not In VersionControl	
	TID #: 00643				
PLOT NAME = Top Assembly Drawing	GENERATED : 9/9/20	015 11:22:12	AM	TEXAS INSTRUMENTS	



## COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: TIDA-00643	REV: E2	SVN REV	: Not In VersionControl	
	TID #: 00643				
PLOT NAME = Bottom Assembly Drawing	GENERATED : 9/9/2	015 11:22:13	AM	TEXAS INSTRUMENTS	

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